TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ($L^2-\pi$ -MOSVI)

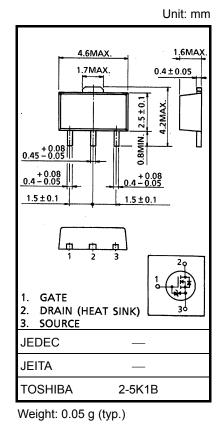
2SK2964

Chopper Regulators, DC-DC Converters and Motor DriveApplications

- 4-V gate drive
- Low drain-source ON-resistance: R_{DS} (ON) = 0.13 Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 2.5 \text{ S} (typ.)$
- Low leakage current: $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 30 \ V)$
- Enhancement mode: $V_{th} = 0.8$ to 2.0 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	30	V
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	30	V
Gate-source voltage		V _{GSS}	±20	V
Drain current	DC (Note 1)	Ι _D	2	А
Brain ouriont	Pulse (Note 1)	I _{DP}	6	А
Drain power dissipation	1	PD	0.5	W
Drain power dissipation (Note 2)		PD	1.5	W
Single pulse avalanche energy (Note 3)		E _{AS}	56	mJ
Avalanche current		I _{AR}	2	А
Repetitive avalanche e	nergy (Note 4)	E _{AR}	0.05	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature range		T _{stg}	-55 to 150	°C



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R _{th (ch−a)}	250	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

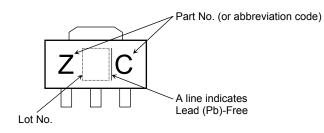
Note 2: Mounted on a ceramic substrate (25.4 mm × 25.4 mm × 0.8 mm)

Note 3: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 10 mH, R_G = 25 Ω , I_{AR} = 2 A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

Marking

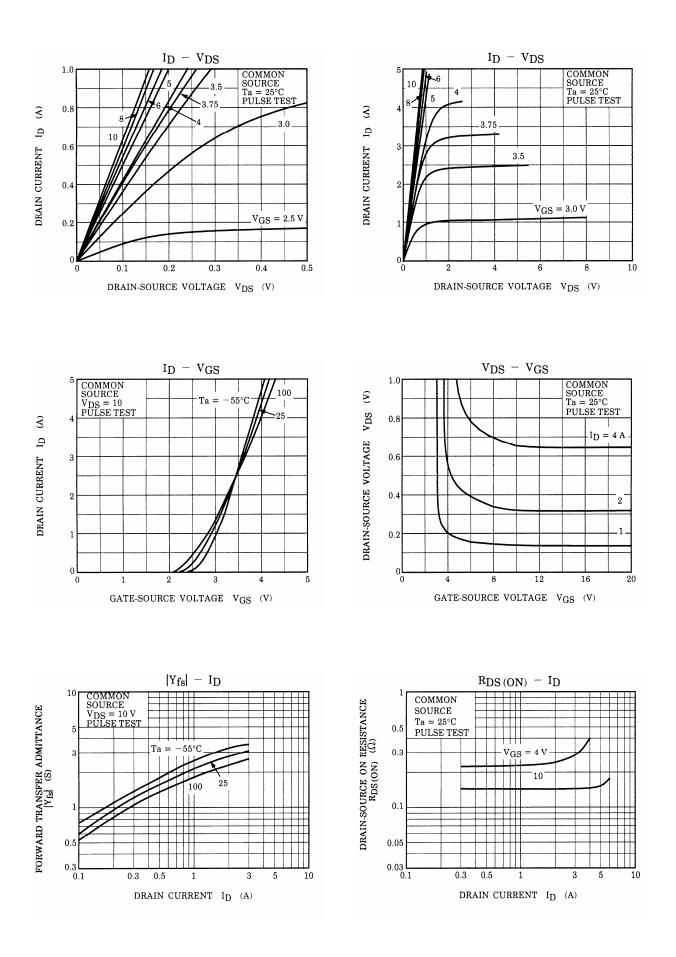


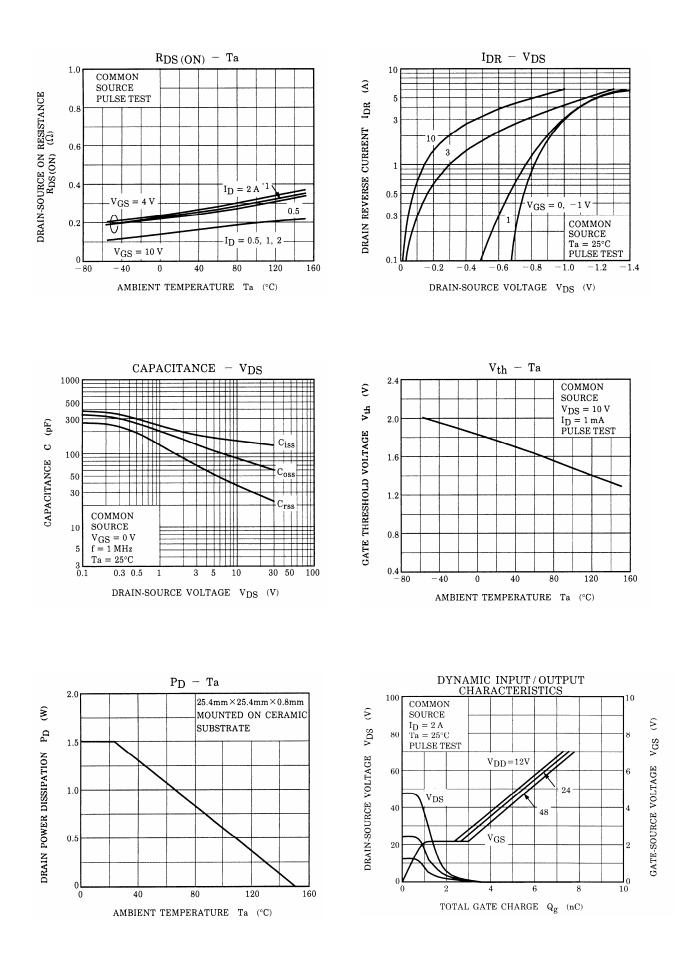
Electrical Characteristics (Ta = 25°C)

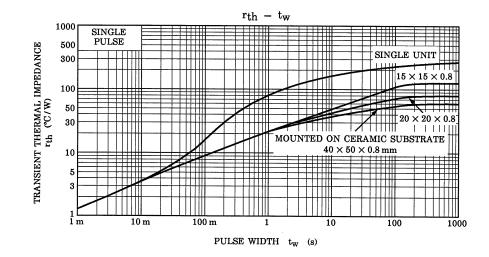
Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V	_	_	±10	μA
Drain cut-off current		I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	—	_	100	μA
Drain-source b	reakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	30	_		V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
Drain-source ON-resistance			V _{GS} = 4 V, I _D = 1 A	—	0.18	0.25	Ω
		R _{DS (ON)}	V _{GS} = 10 V, I _D = 1 A	_	0.13	0.18	
Forward transfe	er admittance	Y _{fs} V _{DS} = 10 V, I _D = 1 A		1.2	2.5	_	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	140		pF
Reverse transfer capacitance		C _{rss}		_	30		
Output capacitance		C _{oss}		_	80	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{10}{}_{0}V \int I_{D} = 1 A$ $V_{GS} \stackrel{10}{}_{0}V \int I_{D} = 1 A$ $G \stackrel{0}{}_{S} \stackrel{0}{}_{H} \stackrel{0}{}_{H} \stackrel{0}{}_{S} \stackrel{0}{}_{H} \stackrel$	_	10	_	
	Turn-on time	t _{on}			15	_	- ns
	Fall time	t _f			85	_	
	Turn-off time	t _{off}			195	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \approx 24 \text{ V}, \text{ V}_{GS}$ = 10 V, I _D = 2 A	_	5.8		nC
Gate-source charge		Q _{gs}		_	4.3		
Gate-drain ("miller") Charge		Q _{gd}	1	_	1.5		

Source–Drain Ratings and Characteristics (Ta = 25°C)

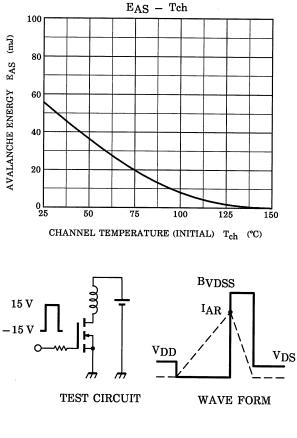
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	2	А
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	6	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 2 A, V _{GS} = 0 V	_	_	-1.5	V
Reverse recovery time	t _{rr}	I _{DR} = 2 A, V _{GS} = 0 V, dI _{DR} /dt = 50 A/μs	_	50	_	ns
Reverse recovery charge	Qrr	$DR = 2 A$, $VGS = 0 V$, $DR/01 = 50 A/\mu s$	_	20	_	nC







SAFE OPERATING AREA ¹⁰E ID MAX. (PULSE) 💥]|||| 5 msЖ 111**N** 3 ID MAX. (CONTINUOUS) 10 ms**※** Ð 1 DRAIN CURRENT ID 0.5 ------0.3 DC OPERATION $Ta = 25^{\circ}C$ 0.1 0.05 0.03 * SINGLE NONREPETITIVE PULSE Ta = 25°C Curves must be derated linearly with increase in temperature. 0.01 V_{DSS} MAX. 0.005 0.003L 0.1 0.3 1 3 10 30 100 DRAIN-SOURCE VOLTAGE V_{DS} (V)



$$\begin{array}{l} \mathrm{R_{G}=25\ \Omega} \\ \mathrm{V_{DD}=25\ V,\ L=10\ mH} \end{array} \qquad \mathrm{E_{AS}=\frac{1}{2}\cdot L\cdot I^{2}\cdot \left(\frac{\mathrm{B_{VDSS}}}{\mathrm{B_{VDSS}-V_{DD}}}\right)} \end{array}$$

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20070701-EN GENERAL

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